



P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
- 30	0.019 at V _{GS} = - 4.5 V	- 11	25	
	0.031 at $V_{GS} = -2.5 \text{ V}$	- 8.5	20	

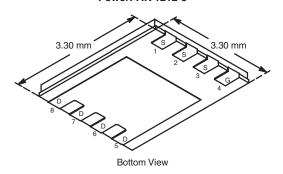
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®]
 Package with Low 1.07 mm Profile
- V_{DS} Optimized for Load Switch
- 100 % R_g Tested



FREE

PowerPAK 1212-8

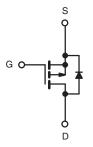


Ordering Information: Si7409ADN-T1-E3 (Lead (Pb)-free)

Si7409ADN-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

· Load Switch



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 30		V	
Gate-Source Voltage		V _{GS}	± 12			
Continuous Dusin Comment /T 450 00\8	T _A = 25 °C	- I _D	- 11	- 7		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 7.9	- 5		
Pulsed Drain Current		I _{DM}	- 40		А	
Continuous Source Current (Diode Conduction) ^a		I _S	- 3.2	- 1.3	l	
Mariana Barra Biraira di ad	T _A = 25 °C	P _D	3.8	1.5	W	
Maximum Power Dissipation ^a	T _A = 85 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian de Ambienta	t ≤ 10 s	R _{thJA}	26	33	°C/W
Maximum Junction-to-Ambient ^a	Steady State		65	81	
Maximum Junction-to-Case	Steady State	R_{thJC}	1.9	2.4	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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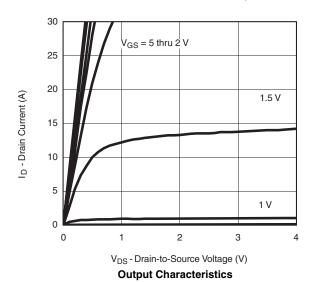
SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.6		- 1.5	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA		
Zava Cata Valtana Duain Comunit	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 1			
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 40			Α		
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 11 A		0.015	0.019	0		
Drain-Source On-State Resistance ^a		$V_{GS} = -2.5 \text{ V}, I_D = -8.5 \text{ A}$		0.025	0.031	Ω		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 11 A		40		S		
Diode Forward Voltage ^a	V_{SD}	I _S = - 3.2 A, V _{GS} = 0 V		- 0.7	- 1.2	V		
Dynamic ^b								
Total Gate Charge	Q_g			25	40	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -11 \text{ A}$		5				
Gate-Drain Charge	Q_{gd}			9				
Gate Resistance	R_g	f = 1.0 MHz	3.3	6.5	10	Ω		
Turn-On Delay Time	t _{d(on)}			30	45			
Rise Time	t _r	V_{DD} = - 15 V, R_{L} = 15 Ω		50	75	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_g=6~\Omega$		115	175			
Fall Time	t _f			75	115			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 3.2 A, dl/dt = 100 A/μs		60	90			
Reverse Recovery Charge	Q _{rr}	i _F = - 3.2 A, αί/αι = 100 A/μS		100	150	nC		

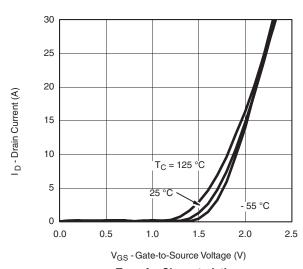
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



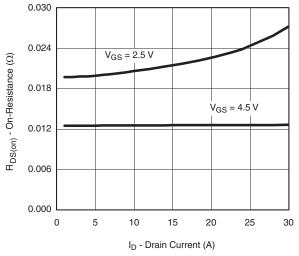




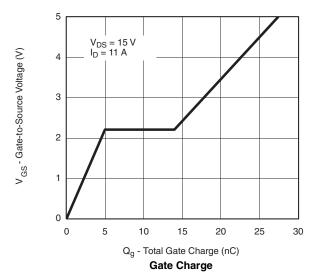


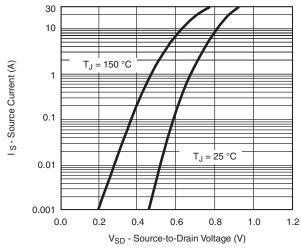


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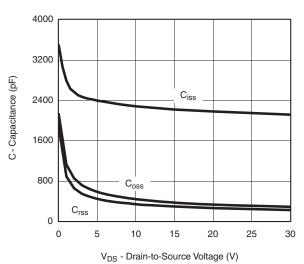


On-Resistance vs. Drain Current

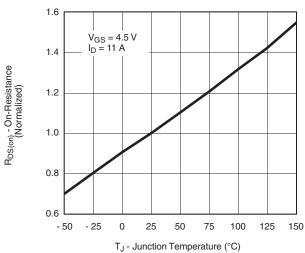




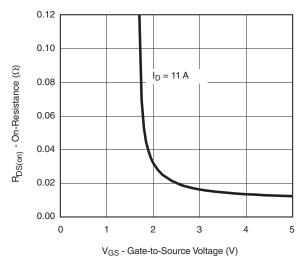
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature

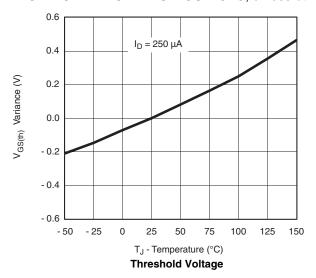


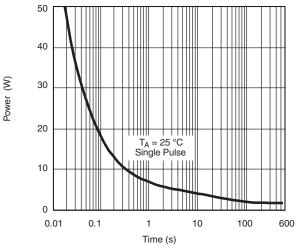
On-Resistance vs. Gate-to-Source Voltage

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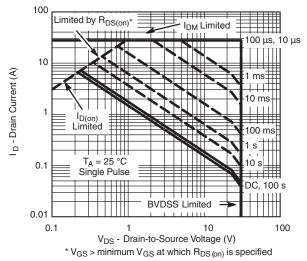
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

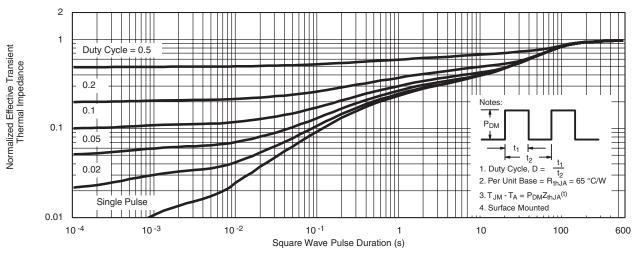




Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

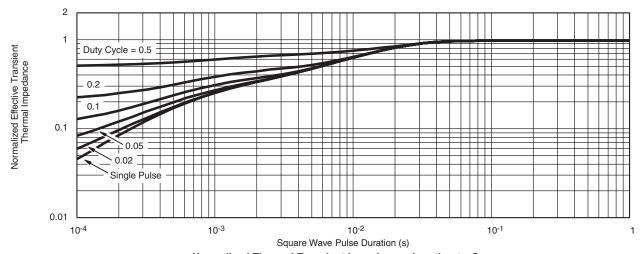


Normalized Thermal Transient Impedance, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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Revision: 18-Jul-08

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